



DUAL N-CHANNEL ENHANCEMENT MODE MOSFET

Product Summary

V _{(BR)DSS}	R _{DS(ON)}	Package	Ι _D T _A = +25°C	
60V	8Ω @ V _{GS} = 5V	SOT363	170mA	
000	$6\Omega @ V_{GS} = 10V$	301303	200mA	

Description

This new generation MOSFET has been designed to minimize the on-state resistance ($R_{DS(on)}$) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

Applications

- DC-DC Converters
- Power Management Functions
- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories, Transistors, etc

Features

- Dual N-Channel MOSFET
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Small Surface Mount Package
- ESD Protected Gate, 1KV (HBM)
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability

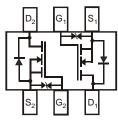
Mechanical Data

- Case: SOT363
- Case Material: Molded Plastic. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Solderable per MIL-STD-202, Method 208 3
- Lead Free Plating (Matte Tin Finish annealed over Alloy 42 leadframe).
- Terminal Connections: See Diagram
- Weight: 0.006 grams (approximate)

SOT363



Top View



Top View Internal Schematic

Ordering Information (Note 4)

Part Number	Case	Packaging
DMN65D8LDW-7	SOT363	3000/Tape & Reel

Notes: 1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

See http://www.diodes.com for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
 Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and

<1000ppm antimony compounds.

4. For packaging details, go to our website at http://www.diodes.com.

Marking Information



MM1 = Product Type Marking Code YM = Date Code Marking Y = Year (ex: U = 2007) M = Month (ex: 9 = September)

Date	Code	Kev

Date Code Key		-										
Year	2007	2008	2009	2010	2011	2012	2013	2014	2015	2016	2017	2018
Code	U	V	W	Х	Y	Z	А	В	С	D	E	F
Month	lan	Feb	Mar	Anr	May	lun	Jul	Aug	Sep	Oct	Nov	Dec
Month	Jan	гер	IVIdi	Apr	lviay	Jun	Jui	Aug	Sep	UCL	NOV	Dec
Code	1	2	3	4	5	6	7	8	9	0	N	D

DMN65D8LDW Document number: DS35500 Rev. 5 - 2

Downloaded from <u>Elcodis.com</u> electronic components distributor

1 of 6 www.diodes.com



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristi	c		Symbol	Value	Units
Drain-Source Voltage			V _{DSS}	60	V
Gate-Source Voltage			V _{GSS}	±20	V
Continuous Drain Current (Note 5) V _{GS} =10V	Steady State	T _A = +25°C T _A = +70°C	ID	180 140	mA
Continuous Drain Current (Note 5) $V_{GS} = 5V$	Steady State	T _A = +25°C T _A = +70°C	ID	150 120	mA
Continuous Drain Current (Note 6) $V_{GS} = 10V$	Steady State	T _A = +25°C T _A = +70°C	ID	200 160	mA
Continuous Drain Current (Note 6) $V_{GS} = 5V$	Steady State	T _A = +25°C T _A = +70°C	ID	170 140	mA
Pulsed Drain Current (10µs pulse, duty cycle = 1%)			IDM	800	mA

Thermal Characteristics

Characteristic	Symbol	Value	Units
Total Power Dissipation (Note 5)	PD	300	mW
Thermal Resistance, Junction to Ambient (Note 5)	R _{0JA}	435	°C/W
Total Power Dissipation (Note 6)	PD	400	mW
Thermal Resistance, Junction to Ambient (Note 6)	R _{0JA}	330	°C/W
Thermal Resistance, Junction to Case (Note 6)	R _{θJc}	139	°C/W
Operating and Storage Temperature Range	T _{J,} T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

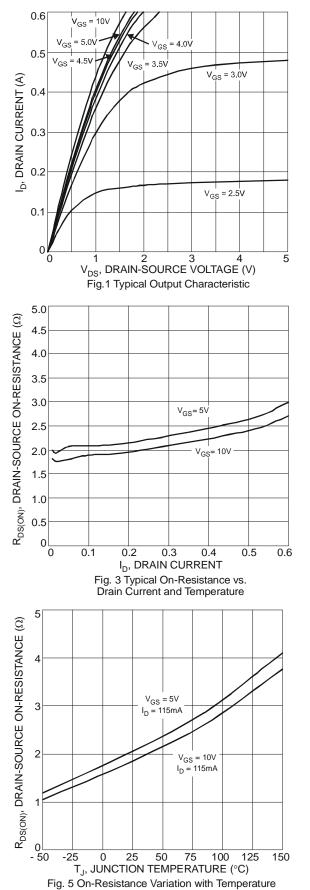
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition	
OFF CHARACTERISTICS (Note 7)					-		
Drain-Source Breakdown Voltage	BV _{DSS}	60			V	$V_{GS} = 0V, I_D = 250 \mu A$	
Zero Gate Voltage Drain Current	IDSS	_	_	1.0	μA	$V_{DS} = 60V, V_{GS} = 0V$	
Gate-Body Leakage	IGSS	_	_	±5.0	μA	$V_{GS} = \pm 20V, V_{DS} = 0V$	
ON CHARACTERISTICS (Note 7)				-	-		
Gate Threshold Voltage	V _{GS(th)}	1.0		2.0	V	$V_{DS} = V_{GS}, I_D = 250 \mu A$	
Static Drain-Source On-Resistance	R _{DS (ON)}	_	_	8	Ω	$V_{GS} = 5.0V, I_D = 0.115A$	
	NDS (ON)	_	_	6	Ω	$V_{GS} = 10.0V, I_D = 0.115A$	
Forward Transconductance	g fs	80	_		mS	$V_{DS} = 10V, I_D = 0.115A$	
Diode Forward Voltage	V _{SD}	-	0.8	1.2	V	$V_{GS} = 0V, I_{S} = 115mA$	
DYNAMIC CHARACTERISTICS (Note 8)							
Input Capacitance	Ciss	_	22.0				
Output Capacitance	Coss		3.2		pF	$V_{DS} = 25V, V_{GS} = 0V, f = 1.0MHz$	
Reverse Transfer Capacitance	C _{rss}		2.0				
Gate Resistance	R _G		79.9		Ω	$V_{DS} = 0V, V_{GS} = 0V, f = 1.0MHz$	
Total Gate Charge V _{GS} = 10V	Qg		0.87				
Total Gate Charge V _{GS} = 4.5V	Qg		0.43		nC	$V_{GS} = 10V, V_{DS} = 30V,$	
Gate-Source Charge	Qgs	_	0.11		ne	I _D = 150mA	
Gate-Drain Charge	Q _{gd}		0.11				
Turn-On Delay Time	t _{D(on)}		3.3	_			
Turn-On Rise Time	tr		3.2	_	nS	$V_{DD} = 30V, I_D = 0.115A, V_{GEN} = 10V,$	
Turn-Off Delay Time	t _{D(off)}		12.0	_	113	$R_{GEN} = 25\Omega$	
Turn-Off Fall Time	t _f		6.3	_			

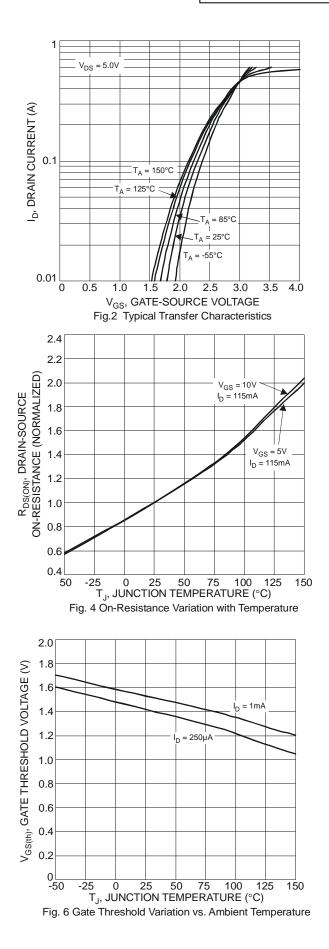
 Device mounted on FR-4 PC board, with minimum recommended pad layout, single sided.
 Device mounted on FR-4 substrate PC board, 2oz copper, with 1inch square copper pad layout Notes:

7 .Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing.

DMN65D8LDW

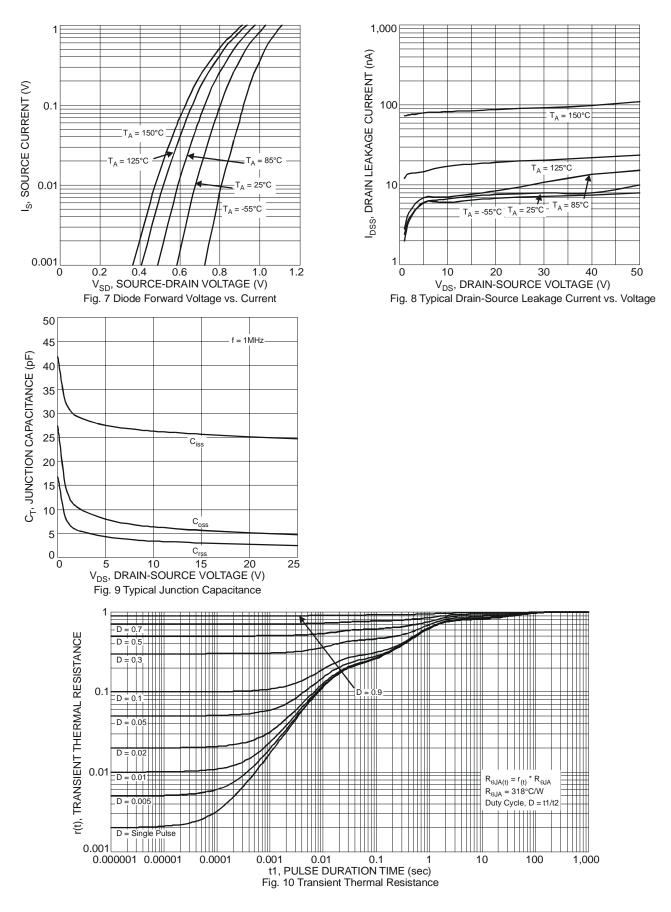






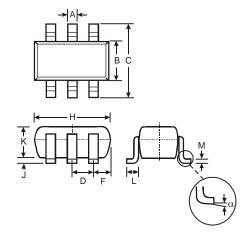
DMN65D8LDW Document number: DS35500 Rev. 5 - 2 Downloaded from <u>Elcodis.com</u> electronic components distributor





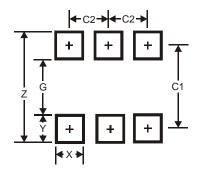


Package Outline Dimensions



SOT363							
Dim	Min	Max	Тур				
Α	0.10	0.30	0.25				
В	1.15	1.35	1.30				
С	2.00	2.20	2.10				
D		0.65 Ty	р				
F	0.40	0.45	0.425				
Н	1.80	2.20	2.15				
J	0	0.10	0.05				
κ	0.90	1.00	1.00				
L	0.25	0.40	0.30				
М	0.10	0.22	0.11				
α	0°	8°	-				
All	Dimen	sions i	n mm				

Suggested Pad Layout



Dimensions	Value (in mm)
Z	2.5
G	1.3
Х	0.42
Y	0.6
C1	1.9
C2	0.65



IMPORTANT NOTICE

DIODES INCORPORATED MAKES NO WARRANTY OF ANY KIND, EXPRESS OR IMPLIED, WITH REGARDS TO THIS DOCUMENT, INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTIES OF MERCHANTABILITY AND FITNESS FOR A PARTICULAR PURPOSE (AND THEIR EQUIVALENTS UNDER THE LAWS OF ANY JURISDICTION).

Diodes Incorporated and its subsidiaries reserve the right to make modifications, enhancements, improvements, corrections or other changes without further notice to this document and any product described herein. Diodes Incorporated does not assume any liability arising out of the application or use of this document or any product described herein; neither does Diodes Incorporated convey any license under its patent or trademark rights, nor the rights of others. Any Customer or user of this document or products described herein in such applications shall assume all risks of such use and will agree to hold Diodes Incorporated and all the companies whose products are represented on Diodes Incorporated website, harmless against all damages.

Diodes Incorporated does not warrant or accept any liability whatsoever in respect of any products purchased through unauthorized sales channel. Should Customers purchase or use Diodes Incorporated products for any unintended or unauthorized application, Customers shall indemnify and hold Diodes Incorporated and its representatives harmless against all claims, damages, expenses, and attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized application.

Products described herein may be covered by one or more United States, international or foreign patents pending. Product names and markings noted herein may also be covered by one or more United States, international or foreign trademarks.

LIFE SUPPORT

Diodes Incorporated products are specifically not authorized for use as critical components in life support devices or systems without the express written approval of the Chief Executive Officer of Diodes Incorporated. As used herein:

- A. Life support devices or systems are devices or systems which:
 - 1. are intended to implant into the body, or
 - 2. support or sustain life and whose failure to perform when properly used in accordance with instructions for use provided in the labeling can be reasonably expected to result in significant injury to the user.
- B. A critical component is any component in a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or to affect its safety or effectiveness.

Customers represent that they have all necessary expertise in the safety and regulatory ramifications of their life support devices or systems, and acknowledge and agree that they are solely responsible for all legal, regulatory and safety-related requirements concerning their products and any use of Diodes Incorporated products in such safety-critical, life support devices or systems, notwithstanding any devices- or systems-related information or support that may be provided by Diodes Incorporated. Further, Customers must fully indemnify Diodes Incorporated and its representatives against any damages arising out of the use of Diodes Incorporated products in such safety-critical, life support devices or systems.

Copyright © 2012, Diodes Incorporated

www.diodes.com